

Description

tML® is a patented, modular cabling system consisting of the three key components module, trunk cable and rack mount enclosure. The system components are 100 percent manufactured, pre-assembled and tested in Germany. They enable plug-and-play installation on site – especially in data centres, but also in industrial environments – within the shortest possible time. Heart of the system are the rear MPO/MTP® and Telco connectors, which can be used to connect at least six or twelve ports at a time. Depending on the module configuration, transfer rates of up to 400G are currently possible with SR4. The fibre optic and TP modules can be used together in a module carrier with a very high port density. The tde offers its tML® cabling system as a proven tML® standard system and in the highly innovative variants tML® 12, tML® 24, tML® 32 and now tML® 24+ System for extreme scalability and very easy migration to higher transmission rates such as 40G, 100G, 200G, 400G and 800G and more.

The tML® - FO Module MPO/MTP® is intended for the installation in the tML® Rack Mount Enclosure 1U (for 8 x Modules).



Technical Data

The end faces of the connectors are optimized by means of Lasercleaving and machine polish. The MPO/MTP® plug has a defined fiber height of 1 - 3,5µ. The max. adjacent fiber height difference is 0.2µm and for all fibers 0.3µm. All system components (modules, trunk cables and patch cords) are co-ordinated for the reaching of the performance particularly. The module is marked with sequential serial number and article number. The modules are ROHS compliant.

Entry	1 x MPO/MTP® Male Adapter (aqua) back
Exit	6 x MU Duplex Adapter front
Tests	Interferometer, Insertion Loss, Return Loss and Visual Final Inspection; all measured values are electronically archived
	QS-Managementsystem ISO 9001, ISO 14001 and TL 9000

Box	Galvanized steel sheet
Front Panel	Stainless steel
Dimensions	110 x 108 x 20 mm

FO Adapters

Type	MPO/MTP®
Application	Multimode OM3
Design	without Flange
Connector style	SC Simplex
Key Orientation	Type A, Key up/down
Color	Aqua
Material	Plastic
Sleeve	--
Shutter	--
Standards	IEC 61754-7 TIA 604-5
Manufacturer	US Conec

Applications

- Fiber optic subscriber network transmission/switching equipment
- CATV
- Active device termination
- Telecommunication networks
- Metro networks
- Local Area Networks (LANS)
- Data processing networks
- Premise installations
- Industrial, military and medical

Features

- Compact design
- NTT-MU hardware compatibility
- NTT & JIS compliance
- High precision alignment
- Low insertion and return loss and back reflection
- Corrosion resistance reflection

FO Adapters

Type	MU Duplex
Sleeve	Zirconia Straight Split
Manufacturer	tde

FO Connectors

Type	MPO/MTP® Male Push Pull Locking (aqua)
Ferrule	12 Fiber MM Elite® ferrule, PPS
Boot colour	Black
Manufacturer	tde/US Conec

Optical Performance

Fiber	Type	Wavelength	Insertion loss typ.	Insertion loss max.	Return loss min.
50/125µ OM3	MPO/MTP®	850 nm	≤ 0.14 dB	0.25 dB	35 dB

FO Connectors

Type	MU
Ferrule	Ceramic
Ferrule Hole	126 µ
Connector colour	Black
Boot colour	Blue
Manufacturer	tde

Optical performance

Fiber	Type	Wavelength	Insertion loss typ.	Insertion loss max.	Return loss min.
50/125µ OM3	MU	850 nm	≤ 0.20 dB	0.35 dB	30 dB

FO Fiber

Type	Corning ClearCurve® 50/125µ OM3 multimode fiber
Optimized Data Rate over Distance	40/100 Gb/s über 140 m* 10 Gb/s over 300 m 1 Gb/s over 1000 m

Standard Compliance	ISO/IEC 11801: type OM3 fiber IEC 60793-2-10: type A1a.2 fiber TIA/EIA: 492AAAC-B ITU: ITU G651.1
*	Distances specified in the 40G/100G per IEEE 802.3ba standard are 150m on OM4 and 100m on OM3; Corning fibers are manufactured to tighter dispersion specifications and thereby support the extended distances shown in the table (assuming cable attenuation ≤ 3.0 dB/km and same 1.0 dB of connector loss for OM3 that the standard requires for OM4).

Optical Specifications

Bandwidth	High Performance EMB* (MHz.km): 2000 at 850 nm only Legacy Performance EMB* (MHz.km): 1500 at 850 nm / 500 at 1300 nm
Attenuation	At 850 nm max. ≤ 2.3 dB/km At 1300 nm max. ≤ 0.6 dB/km
Macrobend Loss	Mandrel Radius (mm): 37.5 / 15 / 7.5 Number of Turns: 100 / 2 / 2 Induced Attenuation (dB) at 850 nm: ≤ 0.05 / ≤ 0.1 / ≤ 0.2 Induced Attenuation (dB) at 1300 nm: ≤ 0.15 / ≤ 0.3 / ≤ 0.5
Numerical Aperture	0.200 \pm 0.015
*	Ensured via miniEMBc, per TIA/EIA 455-220A and IEC 60793-1-49, for high performance laser-based systems (up to 10 Gb/s).
**	OFL BW, per TIA/EIA 455-204 and IEC 60793-1-41, for legacy and LED-based systems (typically up to 100 Mb/s).

Dimensional Specifications

Core Diameter	50.0 \pm 2.5 μ m
Cladding Diameter	125.0 \pm 1.0 μ m
Core-Clad Concentricity	≤ 1.5 μ m
Cladding Non-Circularity	$\leq 1.0\%$
Core Non-Circularity	$\leq 5.0\%$
Coating Diameter	242 \pm 5 μ m
Coating-Cladding Concentricity	< 12 μ m

Environmental

Environmental Test	Test Condition	Induced Attenuation 850 nm & 1300 nm (dB/km)
Temperature Dependence	-60°C to +85°C	≤ 0.10
Temperature Humidity Cycling	-10°C to +85°C and 4% to 98% RH	≤ 0.10
Water Immersion	23°C \pm 2°C	≤ 0.20

Heat Aging	85°C ± 2°C	≤ 0.20
Damp Heat	85°C at 85% RH	≤ 0.20
Operating Temperature Range	-60°C to +85°C	

Mechanical Specifications

Proof Test	The entire fiber length is subjected to a tensile stress ≥ 100 kpsi (0.7 GN/m²).
Length	Fiber lengths available up to 17.6 km/spool.

Performance Characterizations

Refractive Index Difference	1%
Effective Group Index of Refraction	850 nm: 1.480 1300 nm: 1.479
Fatigue Resistance Parameter (nd)	20
Coating Strip Force	Dry: 0.6 lbs (2.7N) Wet: 14 days in 23°C water soak: 0.6 lbs (2.7N)
Chromatic Dispersion	Zero Dispersion Wavelength (λ_0): 1295 nm $\leq \lambda_0 \leq$ 1315 nm Zero Dispersion Slope (S0): ≤ 0.101 ps/(nm²*km)

Art.-No.	Description
TML-M06MUDK/MPP09E	tML® - FO Module MPO/MTP® with Pins/6x MU Duplex 9/125µ OS2
TML-M06MUDK/MPP50G	tML® - FO Module MPO/MTP® with Pins/6x MU Duplex 50/125µ OM2
TML-M06MUDK/MPP50G3	tML® - FO Module MPO/MTP® with Pins/6x MU Duplex 50/125µ OM3
TML-M06MUDK/MPP50G4	tML® - FO Module MPO/MTP® with Pins/6x MU Duplex 50/125µ OM4
TML-M06MUDK/MPP62G	tML® - FO Module MPO/MTP® with Pins/6x MU Duplex 62,5/125µ OM1